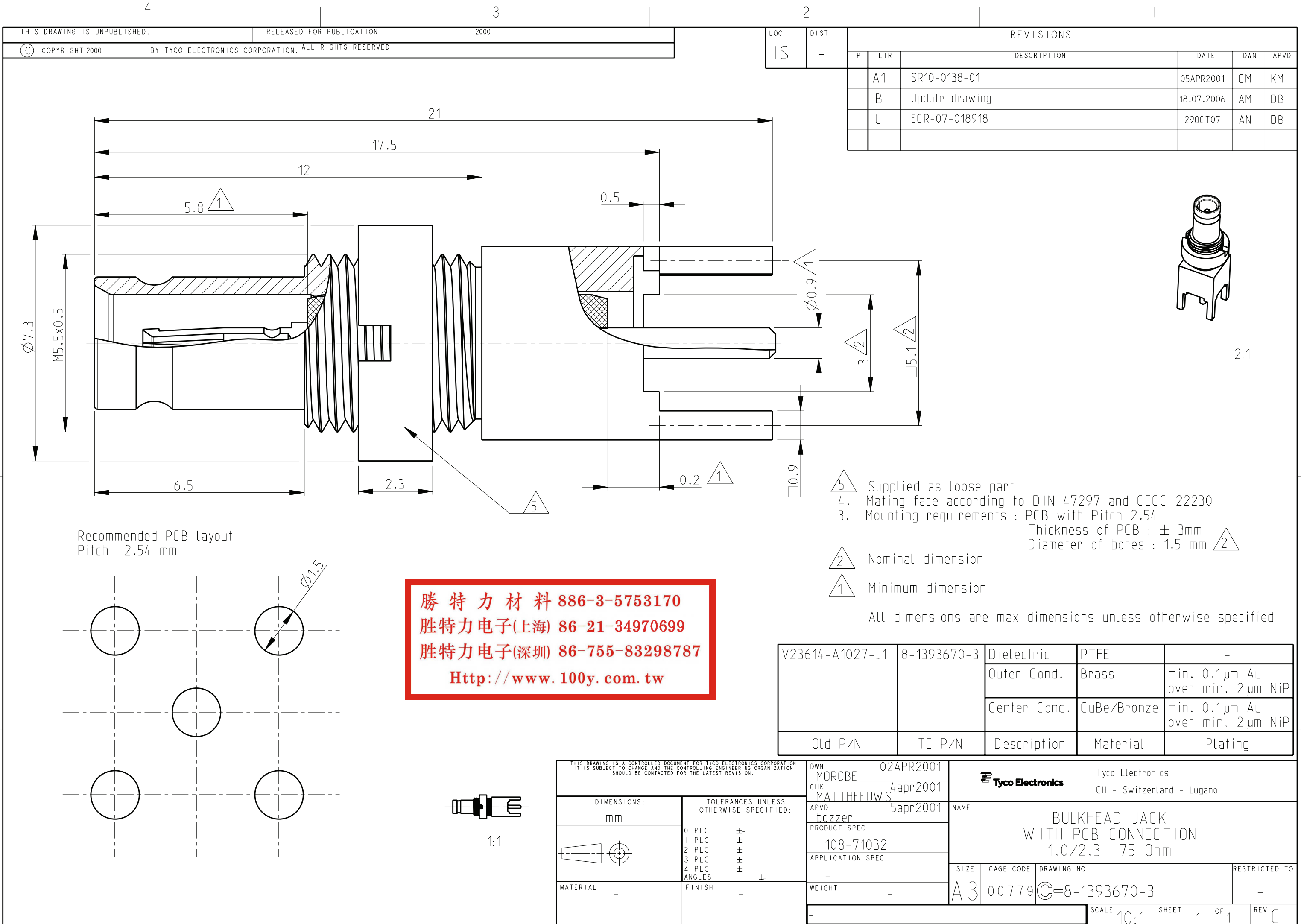
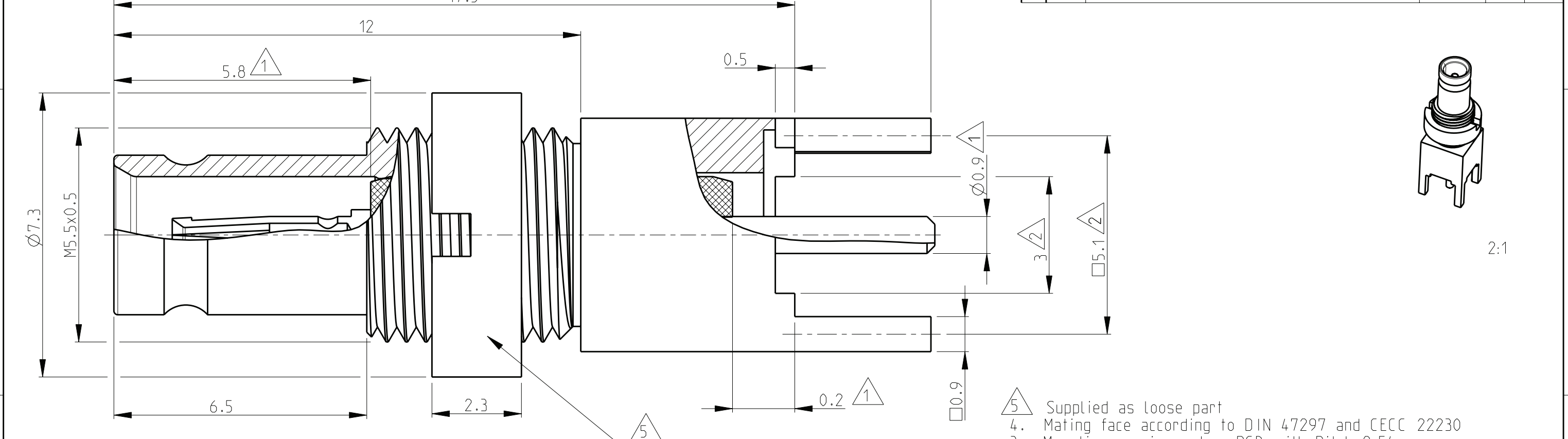




P	LTR	DESCRIPTION	DATE	DWN	APVD
	A1	SR10-0138-01	05APR2001	CM	KM
	B	Update drawing	18.07.2006	AM	DB
	C	ECR-07-018918	29OCT07	AN	DB



Recommended PCB layout
Pitch 2.54 mm

Supplied as loose part
4. Mating face according to DIN 47297 and CECC 22230
3. Mounting requirements : PCB with Pitch 2.54
Thickness of PCB : ± 3 mm
Diameter of bores : 1.5 mm

Nominal dimension
Minimum dimension

All dimensions are max dimensions unless otherwise specified

V23614-A1027-J1	8-1393670-3	Dielectric	PTFE	-
		Outer Cond.	Brass	min. 0.1 μ m Au over min. 2 μ m NiP
		Center Cond.	CuBe/Bronze	min. 0.1 μ m Au over min. 2 μ m NiP
Old P/N	TE P/N	Description	Material	Plating

THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN MOROBE 02APR2001	Tyco Electronics CH - Switzerland - Lugano	
CHK MATTHEEWS 4apr2001		NAME		
APVD hozzer 5apr2001		BULKHEAD JACK WITH PCB CONNECTION 1.0/2.3 75 Ohm		
PRODUCT SPEC 108-71032		SIZE A3	CAGE CODE 00779	DRAWING NO C-8-1393670-3
APPLICATION SPEC		RESTRICTED TO		
MATERIAL -		SCALE 10:1		
FINISH -		SHEET 1 OF 1		
		REV C		